MICROWAVE POWER GaAs FET

Internally Matched Power GaAs FETs (C-Band)

Features

- High power
 - $P_{1dB} = 39.0 \text{ dBm}$ at 3.7 GHz to 4.2 GHz
- High gain
 - $G_{1dB} = 10.0 \text{ dB}$ at 3.7 GHz to 4.2 GHz
- Broad band internally matched
- Hermetically sealed package

RF Performance Specifications (T_a = 25° C)

Characteristics	Symbol	Condition	Unit	Min.	Тур.	Max
Output Power at 1dB Compression Point	P _{1dB}		dBm	38.0	39.0	_
Power Gain at 1dB Compression Point	G _{1dB}	$V_{DS} = 10V$ f = 3.7 ~ 4.2 GHz	dB	9.0	10.0	_
Drain Current	I _{DS}		Α	_	2.2	2.8
Power Added Efficiency	η _{add}		%	_	32	-
Channel-Temperature Rise	ΔT_ch	V _{DS} xI _{DS} xR _{th} (c-c)	°C	_	_	80

Electrical Characteristics (T_a = 25° C)

Characteristic	Symbol	Condition	Unit	Min.	Тур.	Max
Trans-conductance	gm	$V_{DS} = 3V$ $I_{DS} = 3.0 \text{ A}$	mS	_	1800	_
Pinch-off Voltage	V_{GSoff}	$V_{DS} = 3V$ $I_{DS} = 40 \text{mA}$	V	-2	-3.5	-5
Saturated Drain Current	DSS	$V_{DS} = 3V$ $V_{GS} = 0V$	Α	_	5.8	7.5
Gate to Source Breakdown Voltage	$V_{\rm GSO}$	I _{GS} = -120 μA	V	-5	-	_
Thermal Resistance	R _{th (c-c)}	Channel to case	°C/W	-	2.3	3.5

The information contained here is subject to change without notice.

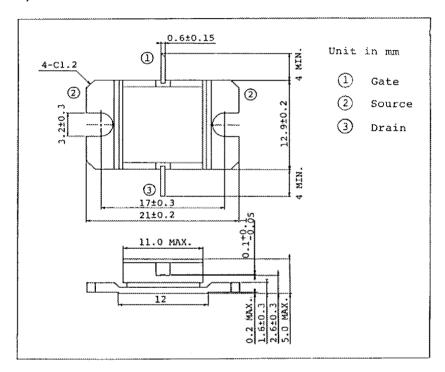
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Absolute Maximum Ratings ($T_a = 25^{\circ} C$)

Characteristic	Symbol	Unit	Rating
Drain Source Voltage	V_{DS}	V	15
Gate Source Voltage	V_{GS}	V	-5
Drain Current	I _D	Α	8
Total Power Dissipation (Tc = 25°C)	P _T	W	37.5
Channel Temperature	T _{ch}	°C	175
Storage Temperature	T _{stg}	°C	-65~175

Package Outline (2-11D1B)

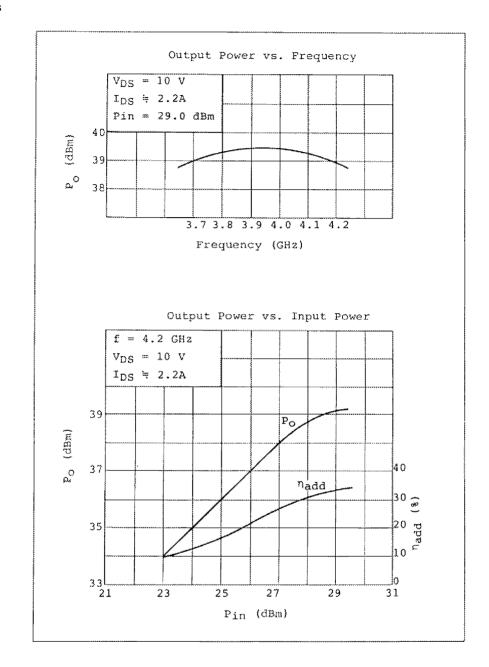


Handling Precautions for Packaged Type

Soldering iron should be grounded and the operating time should not exceed 10 seconds at 260°C.

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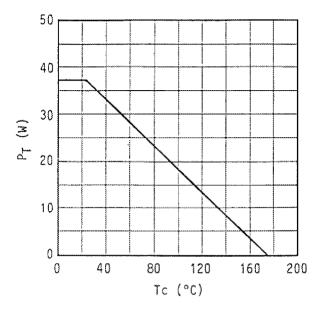
RF Performances



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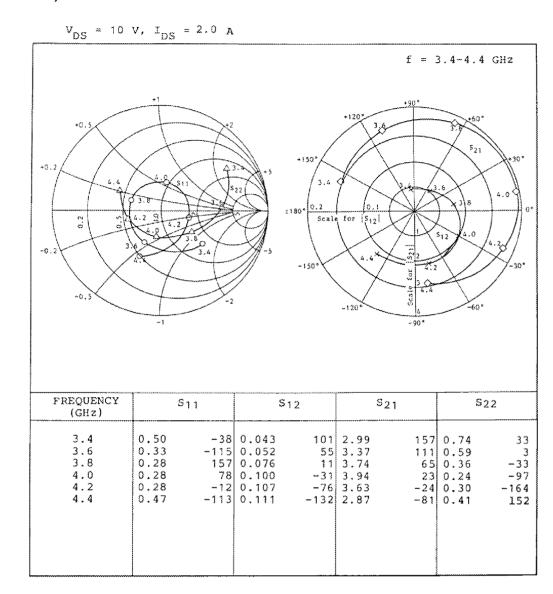
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Power Dissipation vs. Case Temperature



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TPM3742-8 S-Parameters (MAGN. and ANGLES)



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